

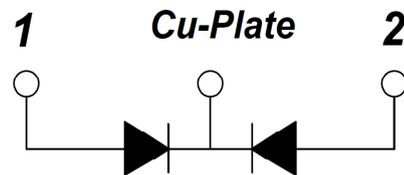
## PRODUCT FEATURES

- Ultrafast Recovery Time
- Low Recovery Loss
- Low Forward Voltage
- Low Leakage Current
- Low Inductance Package



## APPLICATIONS

- Inversion Welder
- Uninterruptible Power Supply
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- PFC



## ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$  unless otherwise specified

| Symbol       | Parameter/Test Conditions                       |  | Values      | Unit                        |
|--------------|---|--|-------------|-----------------------------|
| $V_R$        | Maximum D.C. Reverse Voltage                    |  | 400         | V                           |
| $V_{RRM}$    | Maximum Repetitive Reverse Voltage              |  |             |                             |
| $I_{F(AV)}$  | Average Forward Current                         | $T_C = 110^\circ\text{C}$ , Per Diode                            | 150         | A                           |
|              |   | $T_C = 110^\circ\text{C}$ , Per Module                           | 300         |                             |
| $I_{F(RMS)}$ | RMS Forward Current                             | $T_C = 110^\circ\text{C}$ , Per Diode                            | 210         |                             |
| $I_{FSM}$    | Non Repetitive Surge Forward Current            | $T_J = 45^\circ\text{C}$ , $t = 10\text{ms}$ , Sine, peak value  | 1800        |                             |
|              |   | $T_J = 45^\circ\text{C}$ , $t = 8.3\text{ms}$ , Sine, peak value | 1960        |                             |
| $I^2t$       | For Fusing                                      | $T_J = 45^\circ\text{C}$ , $t = 10\text{ms}$ , Sine, peak value  | 16200       | A <sup>2</sup> S            |
|              |   | $T_J = 45^\circ\text{C}$ , $t = 8.3\text{ms}$ , Sine, peak value | 16000       |                             |
| $P_D$        | Power Dissipation                               |  | 1250        | W                           |
| $T_J$        | Junction Temperature                            |  | -40 to +150 | $^\circ\text{C}$            |
| $T_{STG}$    | Storage Temperature Range                       |  | -40 to +125 | $^\circ\text{C}$            |
| Torque       | Module to Sink                                  | Recommended (M6)   | 3~4.7       | Nm                          |
|              | Module Electrodes                               | Recommended (M6)   |             |                             |
| $R_{thJC}$   | Junction to Case Thermal Resistance(Per Diode ) |  | 0.1         | $^\circ\text{C} / \text{W}$ |
| Weight       |   |  | 92          | g                           |

**ELECTRICAL CHARACTERISTICS**

$T_C=25^{\circ}\text{C}$  unless otherwise specified

| Symbol    | Parameter/Test Conditions   |   | Min. | Typ. | Max. | Unit |
|-----------|---|---|------|------|------|------|
| $I_{RM}$  | Maximum Reverse Leakage Current   | $V_R = 400\text{V}$   |      |      | 0.5  | mA   |
|           |   | $V_R = 400\text{V}, T_J = 125^{\circ}\text{C}$                |      |      | 10   |      |
| $V_F$     | Forward Voltage   | $I_F=150\text{A}$   |      | 1.5  | 2.0  | V    |
|           |   | $I_F=150\text{A}, T_J=125^{\circ}\text{C}$                    |      | 1.2  |      |      |
| $t_{rr}$  | Reverse Recovery Time ( $I_F = 1\text{A}, dI_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$ ) |   |      | 45   |      | ns   |
| $t_{rr}$  | Reverse Recovery Time   | $I_F=150\text{A}, V_R=200\text{V},$                           |      | 70   |      | ns   |
| $I_{RRM}$ | Maximum Reverse Recovery Current  | $dI_F/dt = -200\text{A}/\mu\text{s}$                          |      | 9    |      | A    |
| $t_{rr}$  | Reverse Recovery Time   | $I_F= 150\text{A}, V_R = 200\text{V},$                        |      | 110  |      | ns   |
| $I_{RRM}$ | Maximum Reverse Recovery Current  | $dI_F/dt = -200\text{A}/\mu\text{s}, T_J=125^{\circ}\text{C}$ |      | 15   |      | A    |

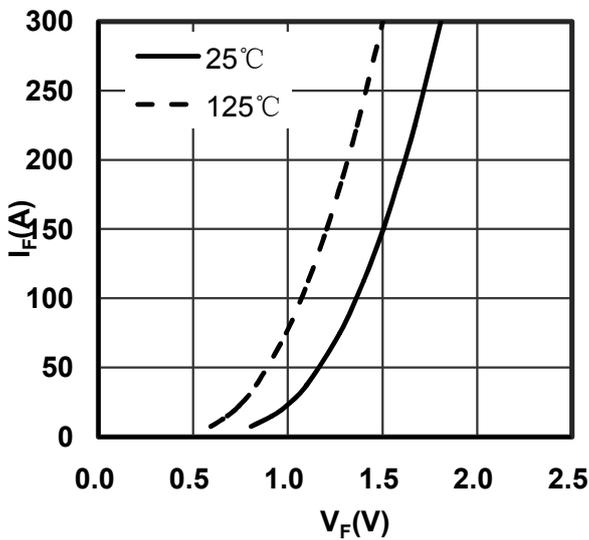


Figure 1. Forward Voltage Drop vs Forward Current

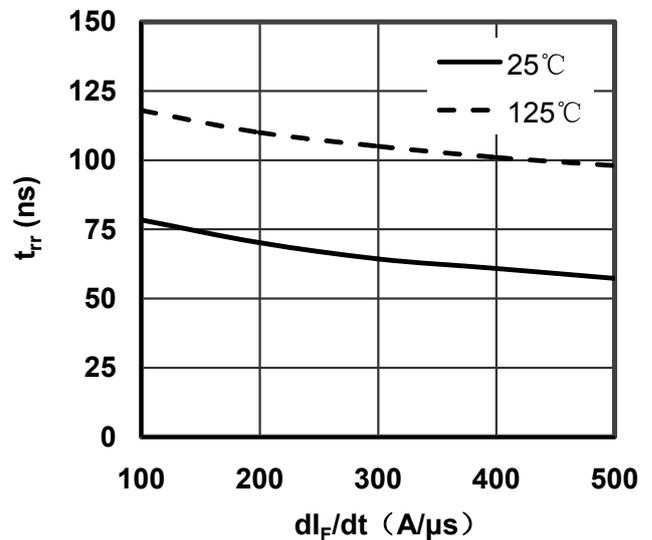


Figure 2. Reverse Recovery Time vs  $dI_F/dt$

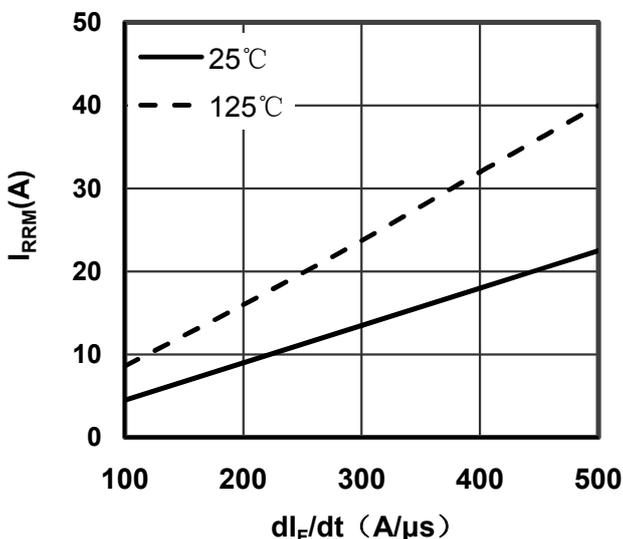


Figure 3. Reverse Recovery Current vs  $dI_F/dt$

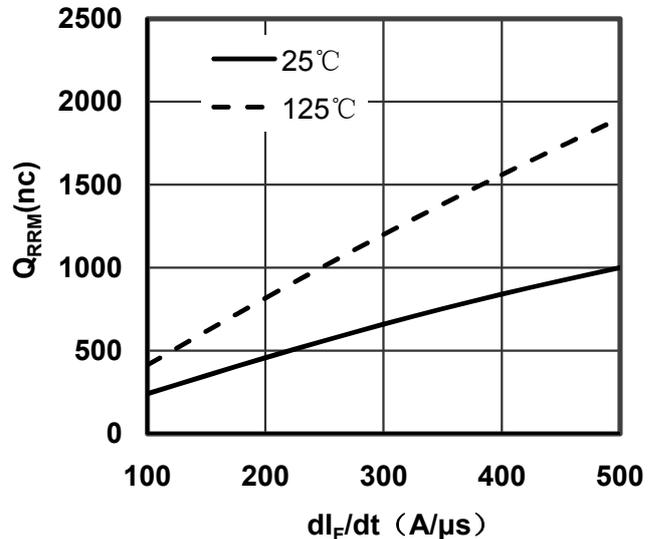


Figure 4. Reverse Recovery Charge vs  $dI_F/dt$

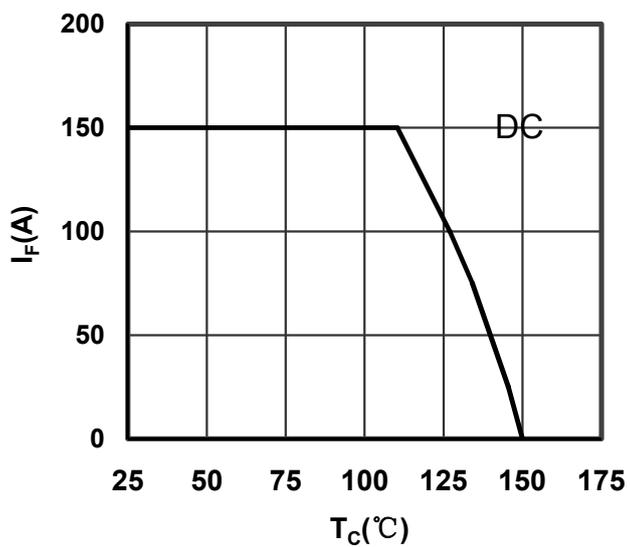


Figure 5. Forward current vs Case temperature

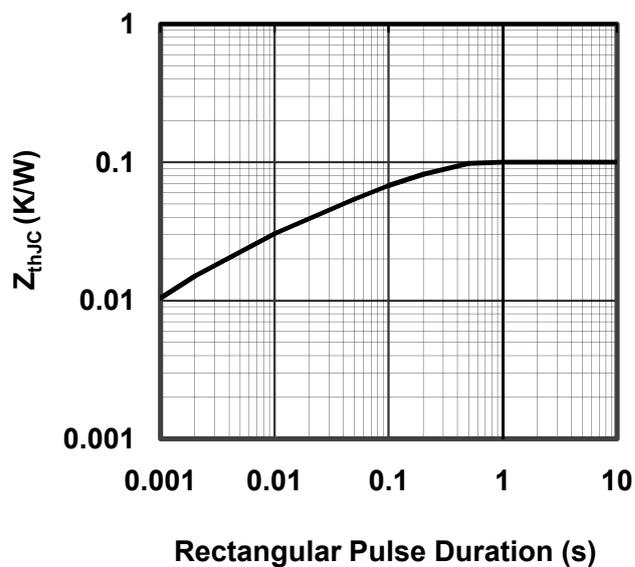
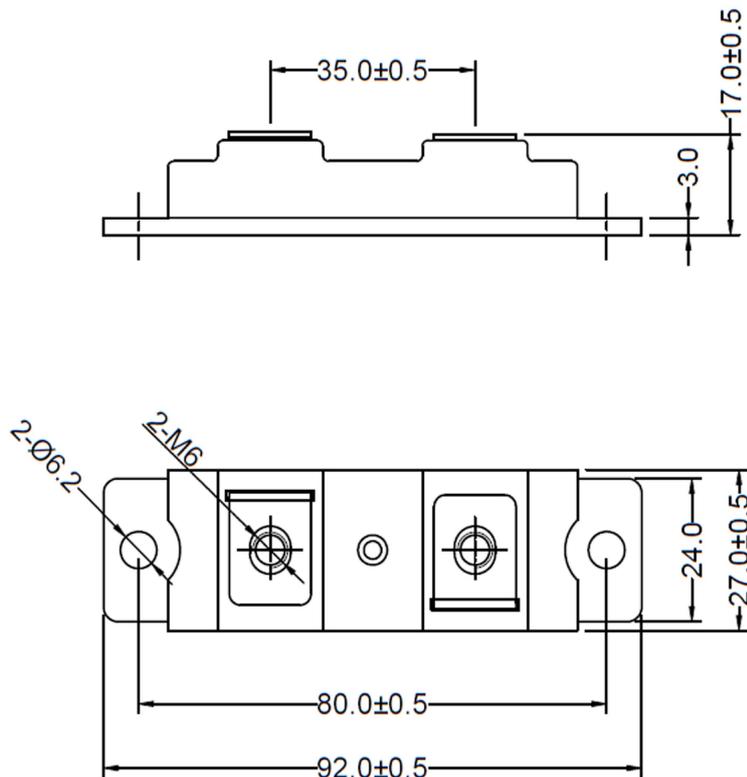


Figure 6. Transient Thermal Impedance



Dimensions in (mm)  
Figure 7. Package Outline